



P-Channel 12-V (D-S) MOSFET

PRODUCT SUMMARY				
V _{DS} (V)	$R_{DS(on)}(\Omega)$	I _D (A)		
- 12	0.027 at V _{GS} = - 4.5 V	- 8.1		
	0.0335 at V _{GS} = - 2.5 V	- 7.3		
	0.045 at V _{GS} = - 1.8 V	- 6.3		

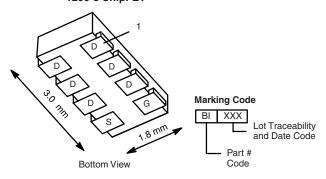
FEATURES

- Halogen-free According to IEC 61249-2-21 Available
- TrenchFET[®] Power MOSFETs
- Low R_{DS(on)} and Excellent Power Handling in Compact Footprint





1206-8 ChipFET®

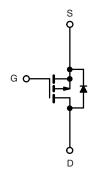


Ordering Information: Si5473DC-T1-E3 (Lead (Pb)-free)

Si5473DC-T1-GE3 (Lead (Pb)-free and Halogen-free)

APPLICATIONS

· Battery and Load Switch for Portable Devices



P-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS	T _A = 25 °C, unles	ss otherwise n	oted			
Parameter		Symbol	5 s	Steady State	Unit	
Drain-Source Voltage		V _{DS}	- 12		V	
Gate-Source Voltage		V _{GS}	± 8			
Continuous Dunin Courset (T. 150 °C)	T _A = 25 °C	I _D	- 8.1	- 5.9		
Continuous Drain Current (T _J = 150 °C) ^a	T _A = 85 °C		- 5.9	- 4.3		
Pulsed Drain Current		I _{DM}	± 20		Α	
Continuous Source Current ^a		I _S	- 2.1	- 1.1		
Mariana Barra Birata di ad	T _A = 25 °C	P _D	2.5	1.3	W	
Maximum Power Dissipation ^a	T _A = 85 °C		1.3	0.7		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150		90	
Soldering Recommendations (Peak Temperature) ^{b, c}			260		°C	

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Typical	Maximum	Unit
Marrian Incation to Ambient	t ≤ 5 s	- R _{thJA}	40	50	°C/W
Maximum Junction-to-Ambient ^a	Steady State		80	95	
Maximum Junction-to-Foot (Drain)	Steady State	R_{thJF}	15	20	

Notes:

- a. Surface Mounted on 1" x 1" FR4 board.
- b. See Reliability Manual for profile. The ChipFET is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.
- c. Rework Conditions: manual soldering with a soldering iron is not recommended for leadless components.

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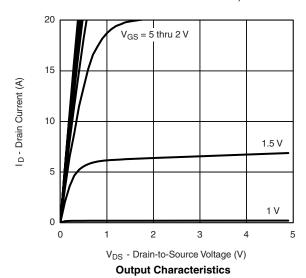
SPECIFICATIONS T _J = 25 °C, unless otherwise noted							
Parameter	Symbol	Test Conditions Min.		Тур.	Max.	Unit	
Static							
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = -250 \mu A$	- 0.40		- 1.0	٧	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 8 V$			± 100	nA	
Zero Gate Voltage Drain Current		V _{DS} = - 9.6 V, V _{GS} = 0 V			-1		
	I _{DSS}	$V_{DS} = -9.6 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 85 ^{\circ}\text{C}$			- 5	μΑ	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \le$ - 5 V, $V_{GS} =$ - 4.5 V	- 20			Α	
		$V_{GS} = -4.5 \text{ V}, I_D = -5.9 \text{ A}$		0.022	0.027	Ω	
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = - 2.5 V, I _D = - 5.3 A		0.028	0.0335		
		V _{GS} = - 1.8 V, I _D = - 2.2 A		0.036	0.045		
Forward Transconductance ^a	9 _{fs}	V _{DS} = - 5 V, I _D = - 5.9 A		20		S	
Diode Forward Voltage ^a	V_{SD}	$I_S = -1.1 \text{ A}, V_{GS} = 0 \text{ V}$		- 0.8	- 1.2	V	
Dynamic ^b							
Total Gate Charge	Q_g			21	32		
Gate-Source Charge	Q _{gs}	$V_{DS} = -6 \text{ V}, V_{GS} = -4.5 \text{ V}, I_{D} = -5.9 \text{ A}$	3.1			nC	
Gate-Drain Charge	Q_{gd}			6.0		1	
Turn-On Delay Time	t _{d(on)}			25	40		
Rise Time	t _r	V_{DD} = - 6 V, R_L = 6 Ω		50	75		
Turn-Off Delay Time	t _{d(off)}	$I_D\cong$ - 1 A, $V_{GEN}=$ - 4.5 V, $R_G=$ 6 Ω		145	220	ns	
Fall Time	t _f			90	135		
Source-Drain Reverse Recovery Time	t _{rr}	$I_F = -1.1 A$, $dI/dt = 100 A/\mu s$		70	105		

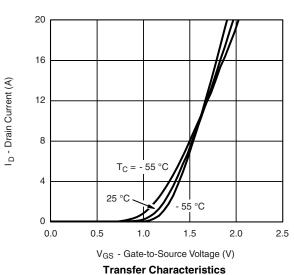
Notes:

- a. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %.
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



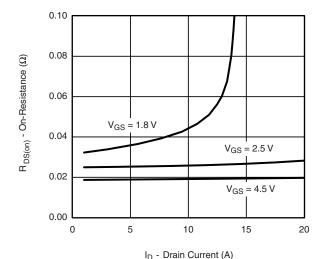




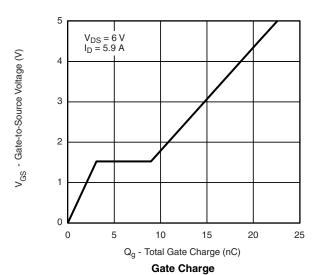


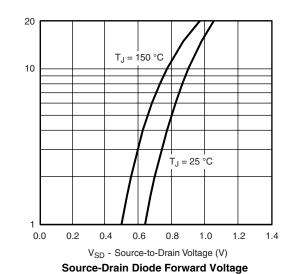


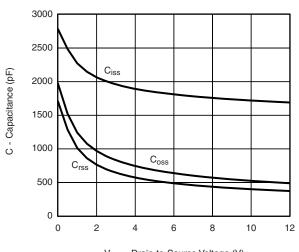
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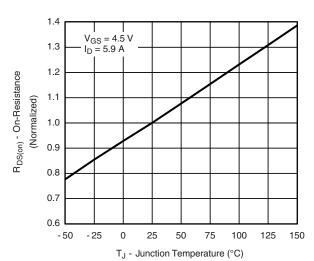
On-Resistance vs. Drain Current



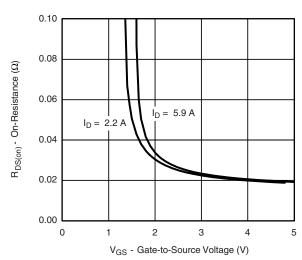




V_{DS} - Drain-to-Source Voltage (V) **Capacitance**



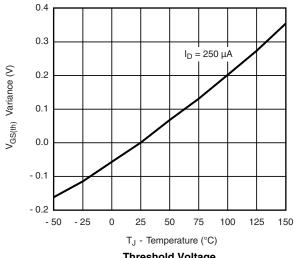
On-Resistance vs. Junction Temperature

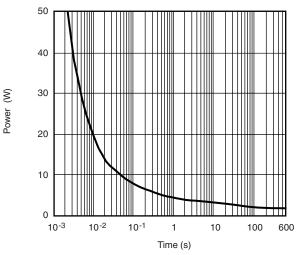


S - Source Current (A)

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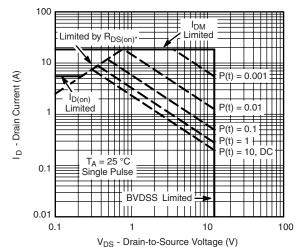
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





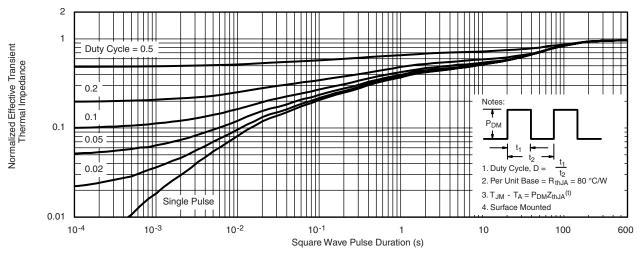
Threshold Voltage

Single Pulse Power



* V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

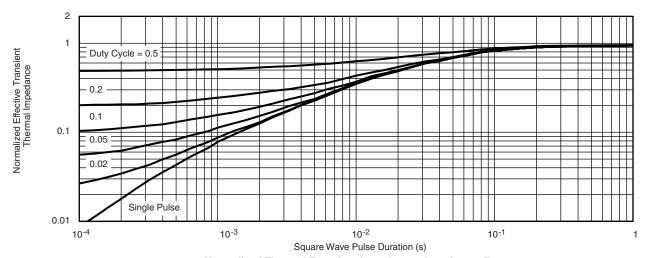
Safe Operating Area



Normalized Thermal Transient Impedance, Junction-to-Ambient



TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Foot

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